

## STY145N65M5

# N-channel 650 V, 0.012 Ωtyp., 138 A, MDmesh™ V Power MOSFET in Max247 package

Datasheet — preliminary data

#### **Features**

Order code	V <sub>DSS</sub> @T <sub>Jmax</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STY145N65M5	710 V	< 0.015 Ω	138 A

- Max247 worldwide best R<sub>DS(on)</sub>
- Higher V<sub>DSS</sub> rating
- Higher dv/dt capability
- Excellent switching performance
- Easy to drive
- 100% avalanche tested

#### **Applications**

Switching applications



The device is an N-channel MDmesh™ V Power MOSFET based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESH™ horizontal layout structure. The resulting product has extremely low onresistance, which is unmatched among siliconbased Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

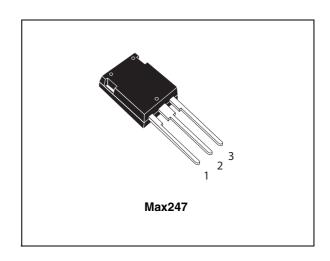


Figure 1. Internal schematic diagram

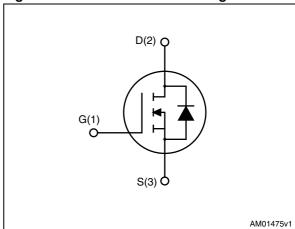


Table 1. Device summary

Order code	Marking	Package	Packaging
STY145N65M5	145N65M5	Max247	Tube

Contents STY145N65M5

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STY145N65M5 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate- source voltage	± 25	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	138	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	87	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	552	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	625	W
I <sub>AR</sub>	Max current during repetitive or single pulse avalanche (pulse width limited by $T_{JMAX}$ )	17	Α
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	2420	mJ
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	15	V/ns
T <sub>stg</sub>	Storage temperature	- 55 to 150	°C
T <sub>j</sub>	Max. operating junction temperature	150	°C

<sup>1.</sup> Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	0.2	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max	30	°C/W
T <sub>I</sub>	Maximum lead temperature for soldering purpose	300	°C

<sup>2.</sup>  $I_{SD} \leq 138 \text{ A}, \text{ di/dt} = 400 \text{ A/}\mu\text{s}, V_{DD} = 400 \text{ V}, \text{ peak } V_{DS} < V_{(BR)DSS}.$ 

Electrical characteristics STY145N65M5

## 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0	650			V
I <sub>DSS</sub>		V <sub>DS</sub> = 650 V V <sub>DS</sub> = 650 V, T <sub>C</sub> =125 °C			10 100	μA μA
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 25 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 69 A		0.012	0.015	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 100 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	18500 413 11	-	pF pF pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	$V_{GS} = 0$ , $V_{DS} = 0$ to 520 V	-	1950	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	$V_{GS} = 0$ , $V_{DS} = 0$ to 520 V	-	415	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	0.7	-	Ω
Qg	Total gate charge	$V_{DD} = 520 \text{ V}, I_{D} = 69 \text{ A},$		414		nC
$Q_{gs}$	Gate-source charge	V <sub>GS</sub> = 10 V	-	114	-	nC
$Q_gd$	Gate-drain charge	(see Figure 15)		164		nC

<sup>1.</sup>  $C_{o(tr)}$  is a constant capacitance value that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

<sup>2.</sup>  $C_{o(er)}$  is a constant capacitance value that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(v)</sub>	Voltage delay time	$V_{DD} = 400 \text{ V}, I_D = 85 \text{ A},$		255		ns
t <sub>r(v)</sub>	Voltage rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$		11		ns
t <sub>f(i)</sub>	Current fall time	(see Figure 16)	_	82	_	ns
t <sub>c(off)</sub>	Crossing time	(see Figure 19)		88		ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current Source-drain current (pulsed)		-		138 552	A A
V <sub>SD</sub> (2)	Forward on voltage	I <sub>SD</sub> = 138 A, V <sub>GS</sub> = 0	-		1.5	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	I <sub>SD</sub> = 138 A, di/dt = 100 A/μs V <sub>DD</sub> = 100 V (see <i>Figure 16</i> )	_	568 14.5 51		ns μC A
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 138 \text{ A, di/dt} = 100 \text{ A/µs}$ $V_{DD} = 100 \text{ V, T}_{j} = 150 \text{ °C}$ (see <i>Figure 16</i> )	-	728 24.5 67		ns μC A

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulsed: pulse duration =  $300 \mu s$ , duty cycle 1.5%

Electrical characteristics STY145N65M5

## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

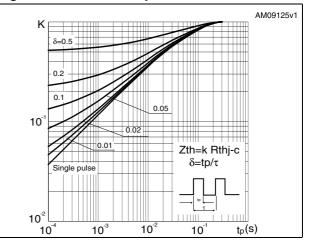


Figure 4. Output characteristics

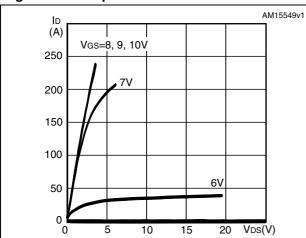


Figure 5. Transfer characteristics

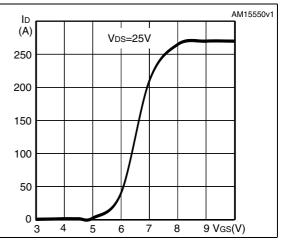
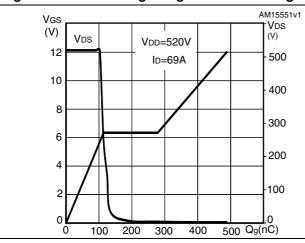
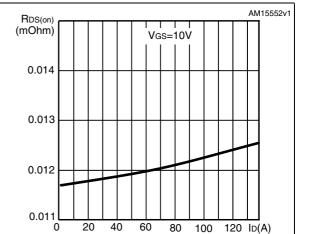


Figure 6. Gate charge vs gate-source voltage Figure 7. Static drain-source on-resistance





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Figure 8. **Capacitance variations** 

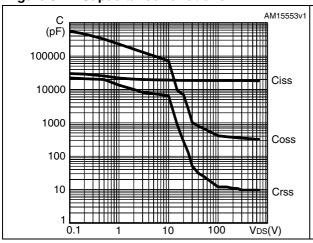


Figure 9. **Output capacitance stored energy** 

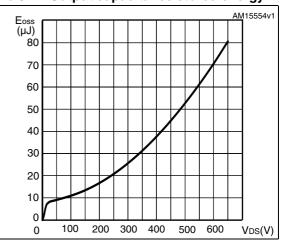
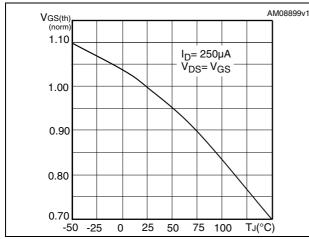


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on-resistance vs vs temperature

temperature



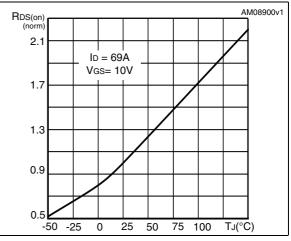
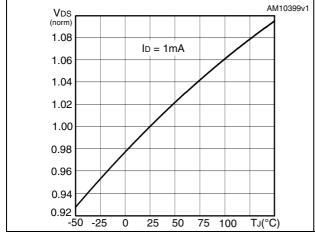
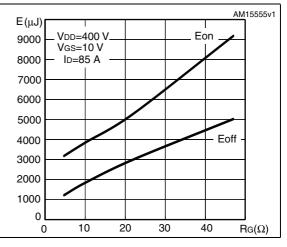


Figure 12. Normalized B<sub>VDSS</sub> vs temperature

Switching losses vs gate Figure 13. resistance<sup>(1)</sup>





1. Eon including reverse recovery of a SiC diode.

Test circuits STY145N65M5

### 3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

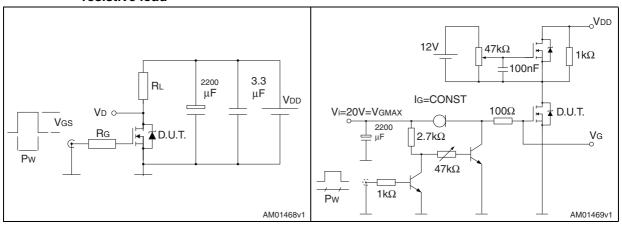


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

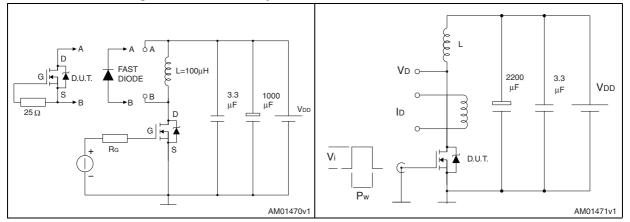
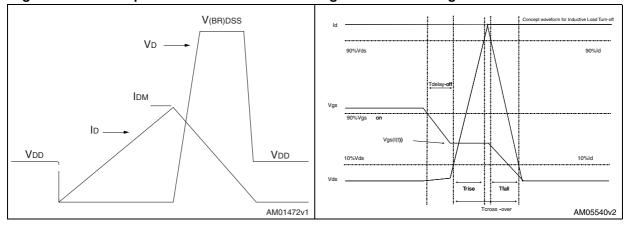


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



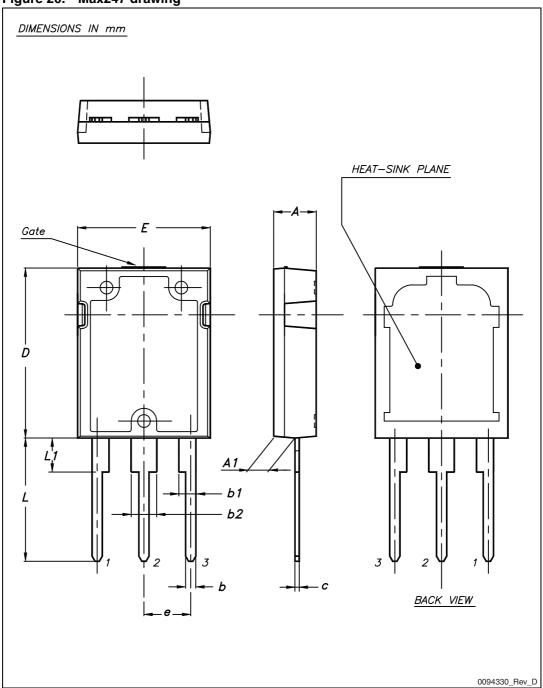
# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 8. Max247 mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.70		5.30
A1	2.20		2.60
b	1.00		1.40
b1	2.00		2.40
b2	3.00		3.40
С	0.40		0.80
D	19.70		20.30
е	5.35		5.55
E	15.30		15.90
L	14.20		15.20
L1	3.70		4.30

Figure 20. Max247 drawing



Revision history STY145N65M5

# 5 Revision history

Table 9. Document revision history

Date	Revision	Changes
25-Sep-2012	1	First release.
17-Jan-2013	2	<ul> <li>Modified: I<sub>AR</sub> and E<sub>AS</sub> values</li> <li>Modified: typical values on <i>Table 5</i>, 6 and 7</li> </ul>

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